## INTEGRATED CIRCUITS

## DATA SHEET

# 74F1488-input priority encoder

**Product specification** 

1990 Mar 01

IC15 Data Handbook





Philips Semiconductors Product specification

## 8-input priority encoder

74F148

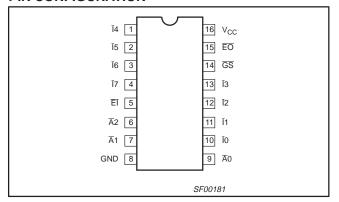
#### **FEATURES**

- Code conversions
- Multi-channel D/A converter
- Decimal-to-BCD converter
- Cascading for priority encoding of "N" bits
- Input enable capability
- Priority encoding-automatic selection of highest priority input line
- Output enable-active Low when all inputs are High
- Group signal output-active when any input is Low

#### **DESCRIPTION**

The 74F148 8-input priority encoder accepts data from eight active-Low inputs and provides a binary representation on the three active-Low outputs. A priority is assigned to each input so that when two or more inputs are simultaneously active, the input with the highest priority is represented on the output, with input line  $\overline{17}$  having the highest priority. A High on the Enable Input ( $\overline{E1}$ ) will force all outputs to the inactive (High) state and allow new data to settle without producing erroneous information at the outputs. A Group Signal ( $\overline{GS}$ ) output and an Enable Output ( $\overline{E0}$ ) are provided with the three data outputs. The  $\overline{GS}$  is active-Low when any input is Low: this indicates when any input is active. The  $\overline{E0}$  is active-Low when all inputs are High. Using the Enable Output along with the Enable Input allows priority encoding of N input signals. Both  $\overline{E0}$  and  $\overline{GS}$  are active-High when the Enable Input is High.

#### **PIN CONFIGURATION**



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F148	6.0ns	23mA

#### ORDERING INFORMATION

DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V $\pm 10\%$ , $T_{amb}$ = 0°C to +70°C	PKG DWG #
16-pin plastic DIP	N74F148N	SOT38-4
16-pin plastic SO	N74F148D	SOT109-1

#### INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Ī1 — Ī7	Priority inputs (active Low)	1.0/2.0	20μA/1.2mA
Ī0	Priority input (active Low)	1.0/1.0	20μA/0.6mA
ΕĪ	Enable input (active Low)	1.0/2.0	20μA/1.2mA
ĒΟ	Enable output (active Low)	50/33	1.0mA/20mA
GS	Group select output (active Low)	50/33	1.0mA/20mA
Ā0 − Ā2	Address outputs (active Low)	50/33	1.0mA/20mA

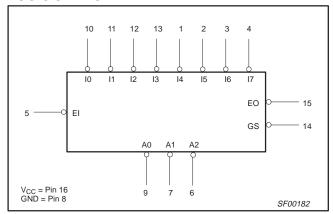
NOTE: One (1.0) FAST unit load is defined as: 20μA in the High state and 0.6mA in the Low state.

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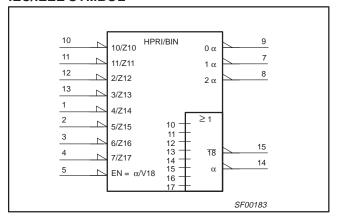
## 8-input priority encoder

74F148

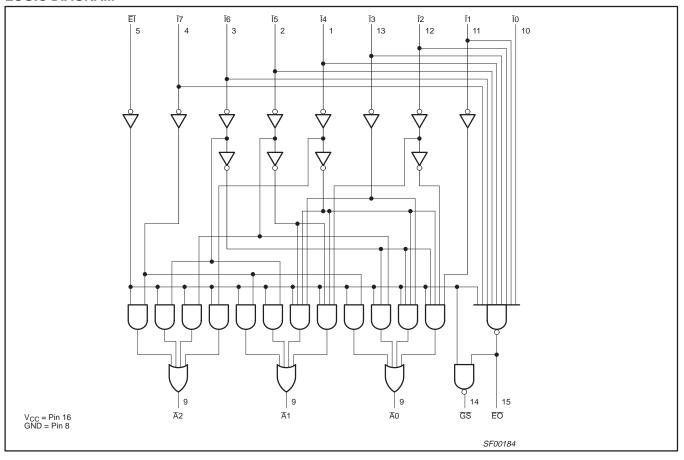
#### **LOGIC SYMBOL**



#### **IEC/IEEE SYMBOL**



#### **LOGIC DIAGRAM**



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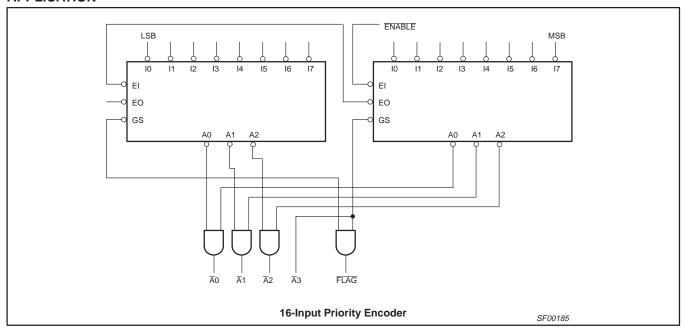
## 8-input priority encoder

74F148

#### **FUNCTION TABLE**

				INPUTS							OUTPUTS	3	
ΕĪ	Ī0	Ī1	Ī2	Ī3	Ī4	Ī5	Ī6	Ī7	GS	Ā0	Ā1	Ā2	ΕO
Н	Х	Х	Х	Х	Х	Х	Х	Х	Н	Н	Н	Н	Н
L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L
L	Х	Х	Х	Х	Х	Х	Х	L	L	L	L	L	Н
L	X	X	Х	X	X	X	L	Н	L	Н	L	L	Н
L	X	X	Х	X	X	L	Н	Н	L	L	Н	L	Н
L	X	X	Х	Χ	L	Н	Н	Н	L	Н	Н	L	Н
L	Х	Х	Х	L	Н	Н	Н	Н	L	L	L	Н	Н
L	X	X	L	Н	Н	Н	Н	Н	L	Н	L	Н	Н
L	X	L	Н	Н	Н	Н	Н	Н	L	L	Н	Н	Н
L	L	Н	Н	Н	Н	Н	Н	Н	L	Н	Н	Н	Н

H = High voltage level
L = Low voltage level
X = Don't care
APPLICATION



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#### ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Supply voltage	-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage	−0.5 to +7.0	V
I <sub>IN</sub>	Input current	−30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state	−0.5 to V <sub>CC</sub>	V
I <sub>OUT</sub>	Current applied to output in Low output state	40	mA
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C

#### RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS		UNIT
STWIBUL	PARAMETER	MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Supply voltage	4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
I <sub>IK</sub>	Input clamp current			-18	mA
I <sub>OH</sub>	High-level output current			-1	mA
I <sub>OL</sub>	Low-level output current			20	mA
T <sub>amb</sub>	Operating free-air temperature range	0		+70	°C

#### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITION	ONE1		LIMITS		UNIT
STWIBOL	PARAMETER		TEST CONDITIO	MIN	TYP <sup>2</sup>	MAX	ONII	
V	Lligh level output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V <sub>CC</sub>	2.5			٧
V <sub>OH</sub>	High-level output voltage		V <sub>IH</sub> = MIN, I <sub>OH</sub> = MAX	±5%V <sub>CC</sub>	2.7	3.4		V
V	Low lovel output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V <sub>CC</sub>		0.30	0.50	٧
V <sub>OL</sub>	Low-level output voltage		V <sub>IH</sub> = MIN, I <sub>OL</sub> = MAX		0.30	0.50	V	
V <sub>IK</sub>	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.2	V
I <sub>I</sub>	Input current at maximum input v	oltage	$V_{CC} = MAX, V_I = 7.0V$			100	μΑ	
I <sub>IH</sub>	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
	Low lovel input ourrent	Ī0	V MAY V 0.5V				-0.6	mA
l I <sub>IL</sub>	Low-level input current	Ī1 – Ī7, <del>E</del> Ī	$V_{CC} = MAX, V_I = 0.5V$				-1.2	mA
I <sub>OS</sub>	Short-circuit output current <sup>3</sup>		V <sub>CC</sub> = MAX		-60		-150	mA
I <sub>CC</sub>	Supply current (total) <sup>4</sup>		V <sub>CC</sub> = MAX			23	35	mA

#### NOTES

- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- 2. All typical values are at  $V_{CC} = 5V$ ,  $T_{amb} = 25$ °C.
- 3. Not more than one output should be shorted at a time. For testing I<sub>OS</sub>, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

4. To measure I<sub>CC</sub>, outputs must be open, V<sub>IN</sub> on all inputs = 4.5V.

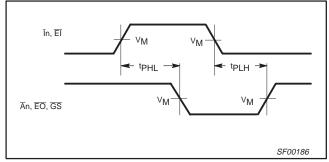
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#### **AC ELECTRICAL CHARACTERISTICS**

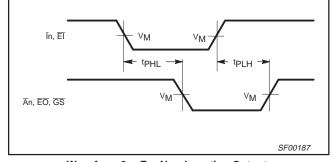
					LIM	ITS		
SYMBOL	PARAMETER	TEST CONDITION	V <sub>0</sub> T <sub>ai</sub> C <sub>L</sub> = 5	<sub>CC</sub> = +5.0 <sub>mb</sub> = +25 0pF, R <sub>L</sub> =	)V °C = 500Ω	V <sub>CC</sub> = +5. T <sub>amb</sub> = 0°C C <sub>L</sub> = 50pF,	UNIT	
			MIN	TYP	MAX	MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay In to Ān	Waveform 2	3.5 3.5	6.0 6.0	9.0 9.0	3.5 3.5	10.0 10.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay In to EO	Waveform 1	1.5 1.5	3.0 2.5	6.5 6.5	1.5 1.5	7.5 7.5	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay In to GS	Waveform 2	2.0 2.0	4.0 4.0	8.0 8.0	2.0 2.0	9.0 9.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay EI to An	Waveform 2	3.5 3.0	6.0 5.5	8.5 8.0	3.5 3.0	9.5 9.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay EI to GS	Waveform 2	2.5 3.0	4.5 5.5	7.0 7.5	2.5 3.0	8.0 8.5	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay EI to EO	Waveform 2	3.0 3.5	5.0 5.0	7.0 7.5	3.0 3.5	8.0 9.0	ns

#### **AC WAVEFORMS**

For all waveforms,  $V_M = 1.5V$ .

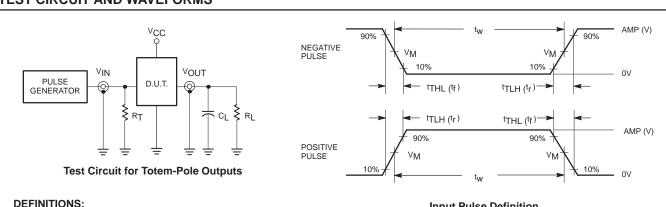


Waveform 1. For Inverting Outputs



Waveform 2. For Non-Inverting Outputs

#### **TEST CIRCUIT AND WAVEFORMS**



#### **DEFINITIONS:**

R<sub>L</sub> = Load resistor; see AC ELECTRICAL CHARACTERISTICS for value.

Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value. Termination resistance should be equal to  $Z_{\text{OUT}}$  of

pulse generators.

#### **Input Pulse Definition**

family	INP	INPUT PULSE REQUIREMENTS												
lailily	amplitude	V <sub>M</sub>	rep. rate	t <sub>w</sub>	t <sub>TLH</sub>	t <sub>THL</sub>								
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns								

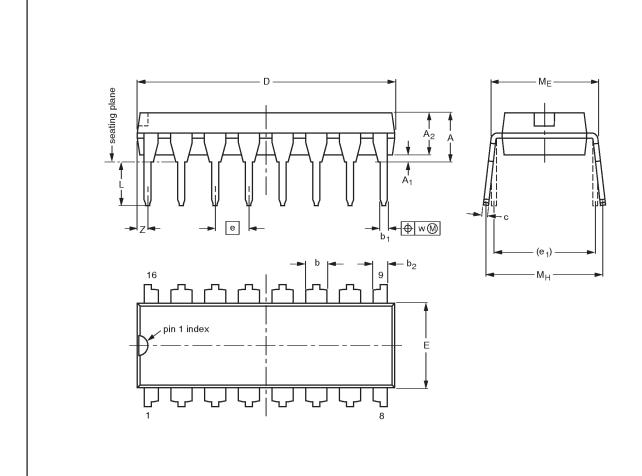
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#### DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UI	NIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	C	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	ME	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
m	nm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inc	hes	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

scale

10 mm

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

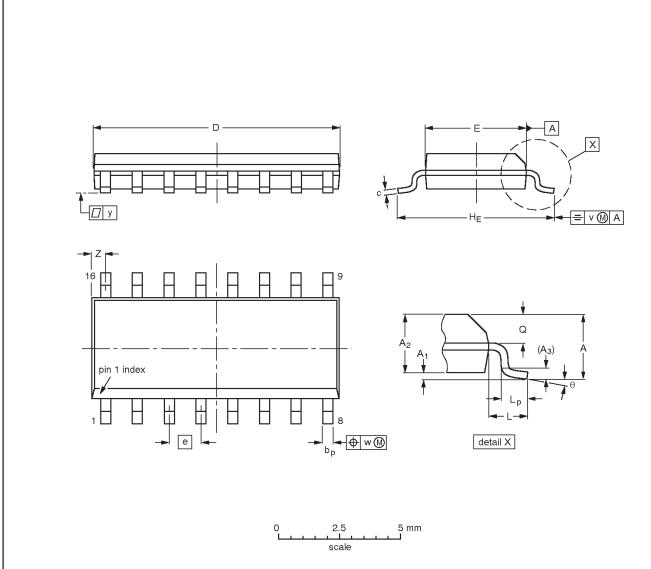
OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	VERSION IEC JEDEC EIAJ		PROJECTION	ISSUE DATE	
SOT38-4					<del>92-11-17</del> 95-01-14

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#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

							_											
UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Ø	٧	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES		EUROPEAN PROJECTION	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ			1990E DATE
SOT109-1	076E07S	MS-012AC				<del>95-01-23</del> 97-05-22

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## 8-input priority encoder

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**NOTES** 

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#### Data sheet status

Data sheet status	Product status	Definition [1]	
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.	
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.	
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible produc	

<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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